

NP50R12K2T

NPT & Rugged Type 1200V IGBT Module

Features

- $BV_{CES}=1200V$
- Low Conduction Loss: $V_{CE(sat)} = 2.7 V @ I_C=50A$
- Fast & Soft Anti-Parallel FWD
- Short Circuit rated: 10us at $T_C=100^\circ C$
- Isolation Type Package

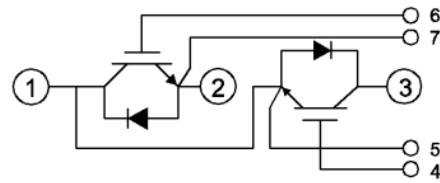
Applications

- Induction Heating, Motor Drives, High Power Inverters
- Welding Machine, UPS

Description

The IGBT Module 7SM-1 package devices are optimized to reduce losses and switching noise in high frequency power conditioning electrical systems.

These IGBT Module series are ideally suited for IH ,High Power inverters, Motors drives and other applications where switching losses are significant portion of the total losses.



Equivalent Circuit



package

Absolute Maximum Ratings (at $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		1200	V
V _{GES}	Gate to Emitter Voltage		±20	V
I _C	Collector Current	T _C =25℃	75	A
		T _C =100℃	50	A
I _{CM}	Pulsed Collector Current , tp=1ms		100	A
I _F	Diode Continuous Forward Current	T _C =100℃	30	A
I _{FM}	Diode Maximum Forward Current		60	A
P _D	Maximum Power Dissipation	T _C =25℃	416	W
T _J	Operating Junction Temperature Range		-55~+150	℃
T _{STG}	Storage Temperature Range		-55~+125	℃
V _{iso}	Isolation Voltage	AC 1minute	2500	V
	Mounting screw Torque: M6		4	N.M
	Weight		155	g

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)} (IGBT)$	Thermal Resistance, Junction to case for IGBT	0.3	$^\circ C/W$
$R_{th(J-C)} (Diode)$	Thermal Resistance, Junction to case for Diode	0.8	$^\circ C/W$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	0.05	$^\circ C/W$

Electrical Characteristics of IGBT @T_C=25 °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} =0V, I _C =1mA	1200	-	-	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C =50A, V _{GE} =15V	-	2.7	-	V
		I _C =50A, V _{GE} =15V, T _C =100 °C	-	3.3	-	V
V _{GE(th)}	Gate Threshold Voltage	V _{CE} =V _{GE} , I _C =2mA	4.5	-	7.5	V
I _{CES}	Zero Gate Voltage Collector Current	V _{CE} =V _{CES} , V _{GE} =0V	-	-	1	mA
I _{GES}	Gate to Emitter Leakage Current	V _{GE} =V _{GES} , V _{CE} =0V	-	-	±250	nA

Electrical Characteristics of Diode @T_C=25 °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V _F	Diode Forward Voltage	I _F =30A	-	3.0	3.6	V
		I _F =30A, T _C =100 °C	-	2.2	-	V
t _{rr}	Diode Reverse Recovery Time	I _F =30A, di/dt=-200A/us	-	80	-	ns
I _{rr}	Diode Peak Reverse Recovery Current		-	9.0	-	A
Q _{rr}	Diode Reverse Recovery Charge		-	240	-	nC
t _{rr}	Diode Reverse Recovery Time	I _F =30A, di/dt=-200A/us, T _C =100 °C	-	150	-	ns
I _{rr}	Diode Peak Reverse Recovery Current		-	14	-	A
Q _{rr}	Diode Reverse Recovery Charge		-	850	-	nC

Switching Characteristics @T_C=25 °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t _{d(on)}	Turn-on Delay Time	I _C =50A, V _{CC} =600V, V _{GE} =±15V, R _G =10Ω, Inductive Load	-	80	-	ns
t _r	Turn-on Rise Time		-	85	-	ns
t _{d(off)}	Turn-off Delay Time		-	240	-	ns
t _f	Turn-off Fall Time		-	60	-	ns
E _{on}	Turn-on Switching Loss		-	3.6	-	mJ
E _{off}	Turn-off Switching Loss		-	3.0	-	mJ
E _{ts}	Total Switching Loss		-	6.6	-	mJ
C _{ies}	Input Capacitance	V _{GE} =0V, V _{CE} =30V, f=1.0MHz	-	3400	-	pF
C _{res}	Reverse Transfer Capacitance		-	370	-	pF
C _{oes}	Output Capacitance		-	125	-	pF
Q _g	Total Gate Charge	I _C =50A, V _{CC} =600V V _{GE} =±15V	-	220	-	nC
Q _{ge}	Gate to Emitter Charge		-	25	-	nC
Q _{gc}	Gate to Collector Charge		-	130	-	nC
t _{sc}	Short Circuit Withstand Time	V _{CC} =600V, V _{GE} =±15V R _G =10Ω @T _C =100 °C	10	-	-	us

Typical Performance Characteristics

Fig. 1. Typical Output Characteristics

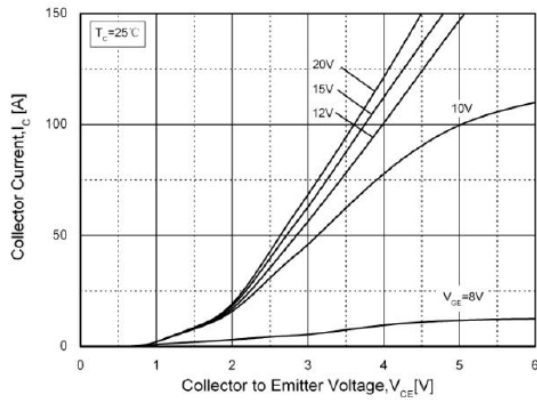


Fig. 2. Typical Output Characteristics

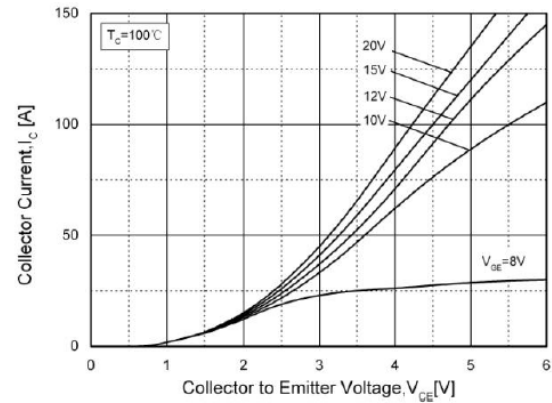


Fig. 3. Typical Saturation Voltage Characteristics

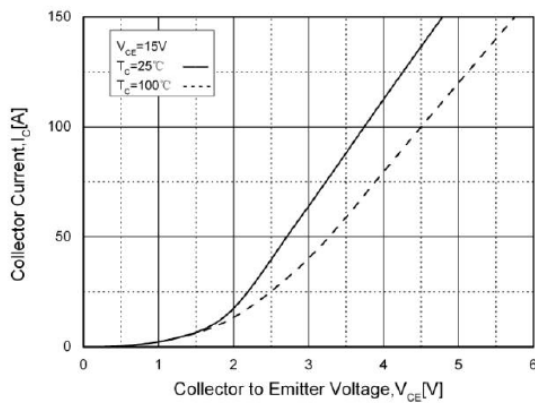


Fig. 4. Gate Charge Characteristics

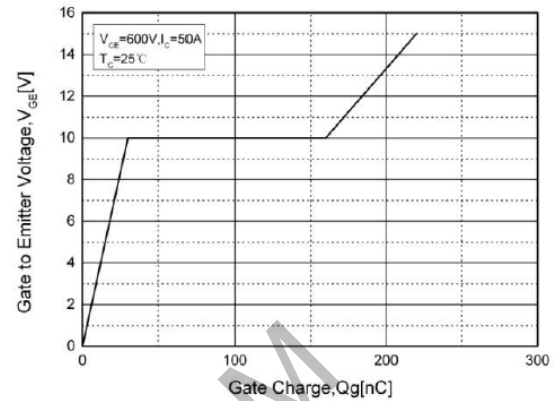


Fig. 5. Turn-on Characteristics vs. R_G

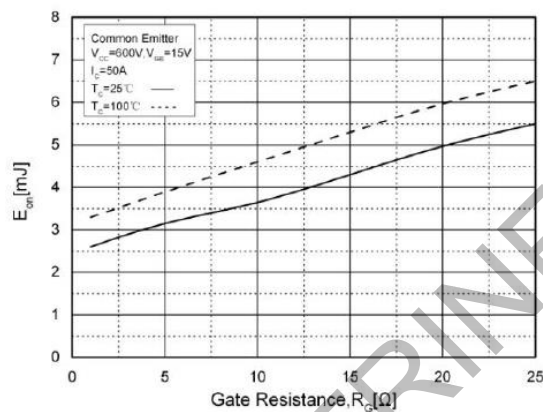
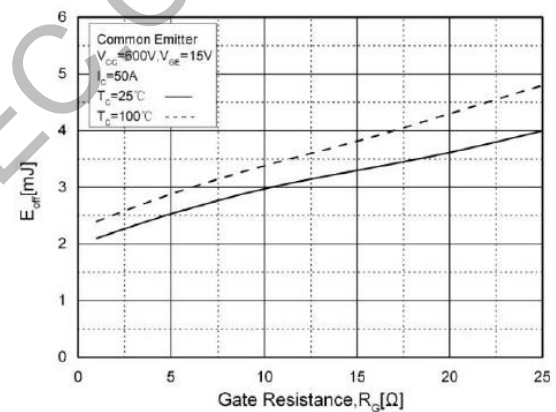


Fig. 6. Turn-off Characteristics vs. R_G



Typical Performance Characteristics

Fig. 7. Rate Current vs. T_C

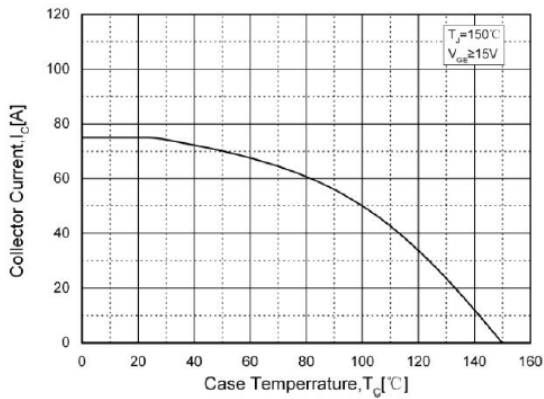


Fig. 8. Power Dissipation vs. T_C

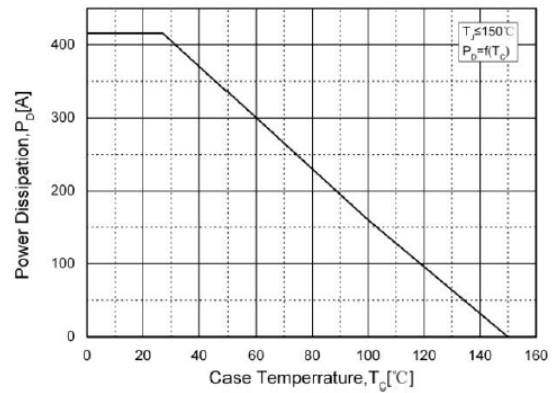


Fig. 9. Transient Thermal Impedance

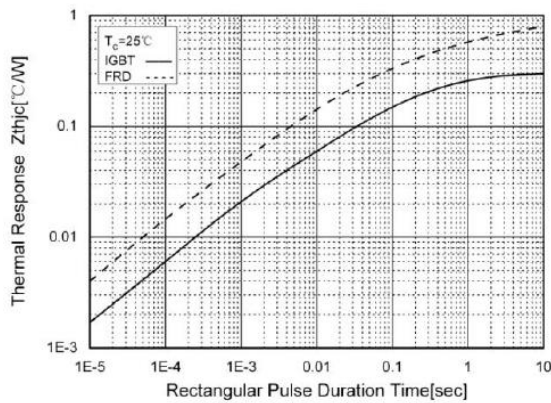
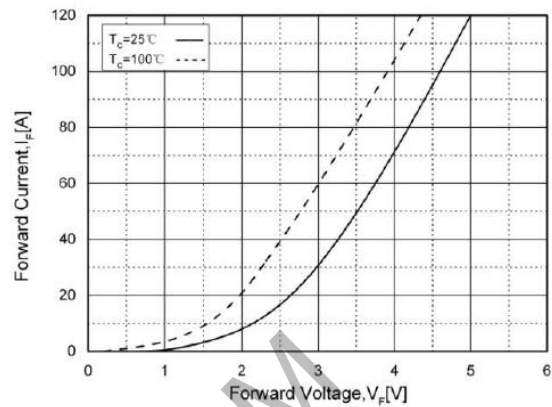
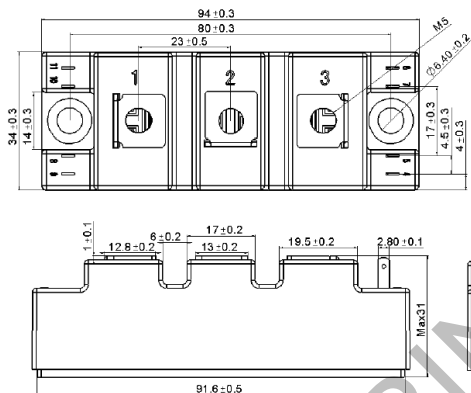


Fig. 10. Forward Characteristics



(Dimensions in Millimeters)



DISCLAIMER:

The products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any product can reasonably be expected to result in a personal injury. Seller's customers using or selling seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.